

Preliminary test on BSRF for TaichuPix3

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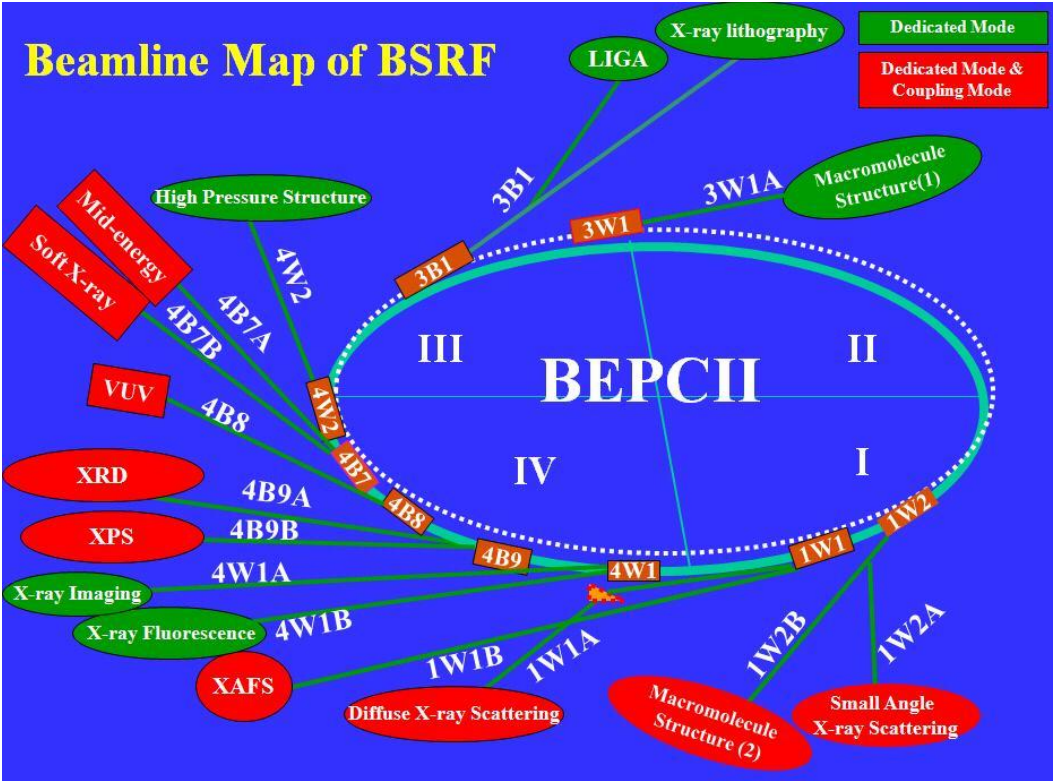
Timeline for TaichuPix3 experiment

- Reservation: From 2022.11.14 to 2022.11.21
- Day1 LGAD test to find electrons beam
- Day2 Two layers of TaichuPix3 test board installation and Data Acquisition with 2 layers of TaichuPix3 test board
- Day3 Three layers of TaichuPix3 test board installation
- Day4 Data Acquisition with 3 layers of TaichuPix3 test board
- Day5 Five Layers of TaichuPix3 test board installation
- Day6 Data Acquisition with 5 layers of TaichuPix3 test board(4 test board Version1.1, 1 test board Version 1.2)
- Day7 Data Acquisition with 5 layers of TaichuPix3 new test board(3 Version 1.2,2 version 1.1)
- End



Introduction of beamline

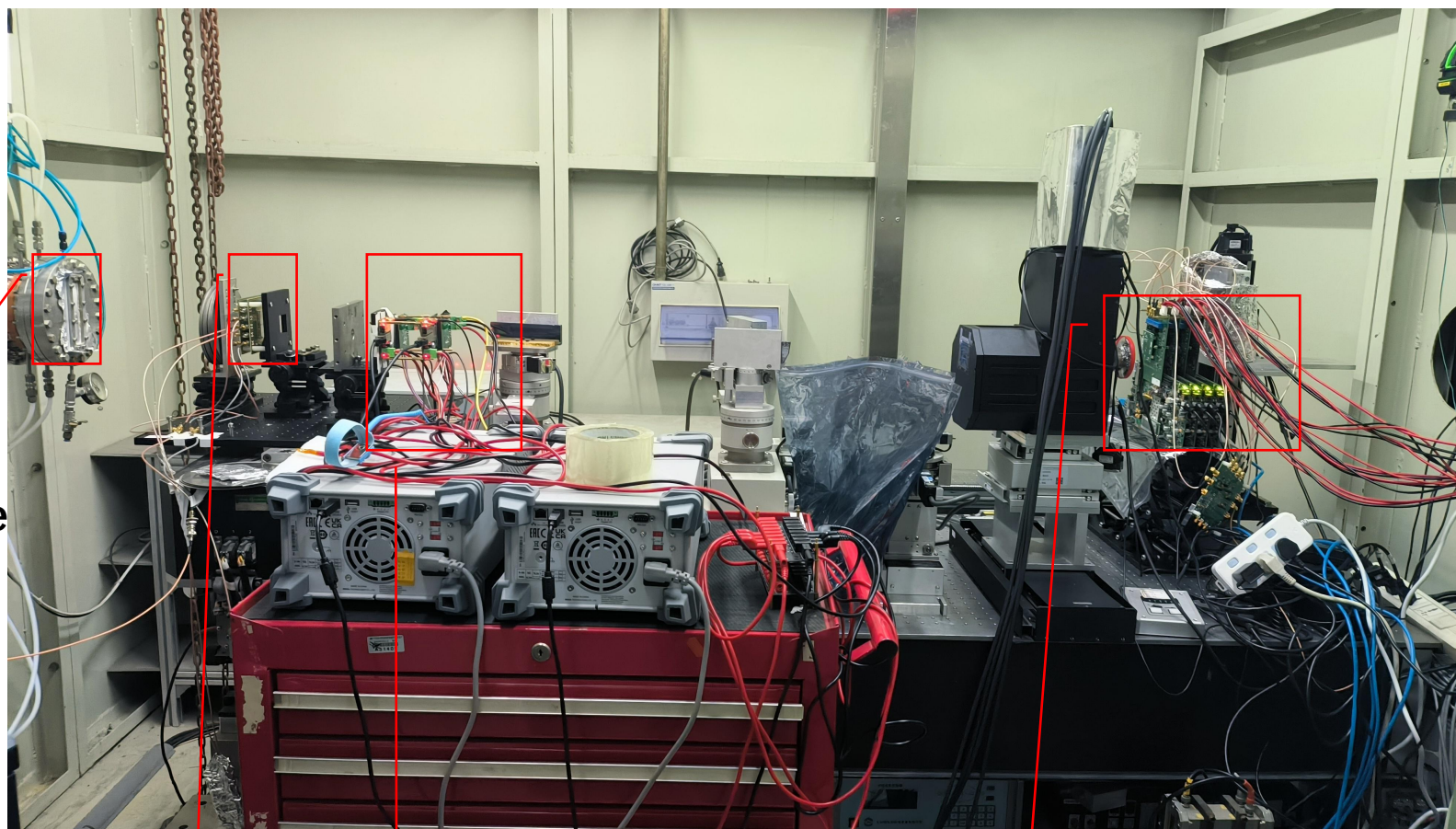
- 4W1A is a X-ray Imaging beamline and locate at IV quadrant of BEPC and 12# experimental hall. It' s mainly used for crystal morphology and Phase-contrast imaging.



Beamline Specs	
Source	Wiggler
Imaging Mode	Phase contrast imaging
Energy Range	6-22 keV
Flux (photons/sec)	10 ¹⁰ @ 8keV
Spatial Resolution	10 μm
Beam Size (HxV)	20mm x 10mm
Imaging Mode	Nano-resolution Imaging
Energy Range	5-12 keV
Flux (photons/sec)	10 ⁸ @ 8keV
Spatial Resolution	30nm, 50nm, 100nm
Beam Size (HxV)	10μm x 10μm, 15μm x15μm, 60μm x60μm



Overview of the beam test setup



Beam source

2 layers LGAD

2~5 layers TaichuPix3

4 layers JadePix3

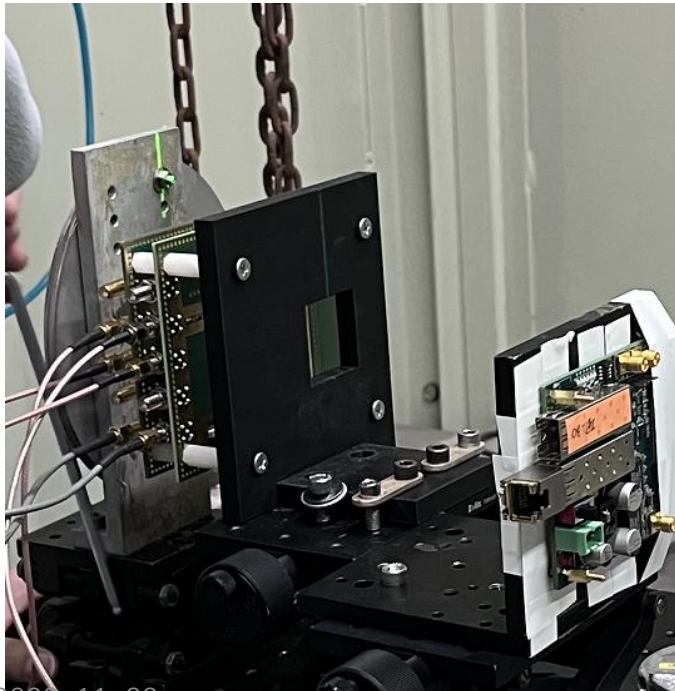
- MOST2 vertex detector team proposed to use electrons beam in BSRF to test TaichuPix3 Telescope
- Jadepix team joined BSRF team





Response from LGAD

- LGAD area: frontend with 2.6mmx2.6mm, backend with 6.5mmx6.5mm
- Coincidence Hit rate: around 20 hit coincidence per minute, average to 0.34 coincidence hit per second

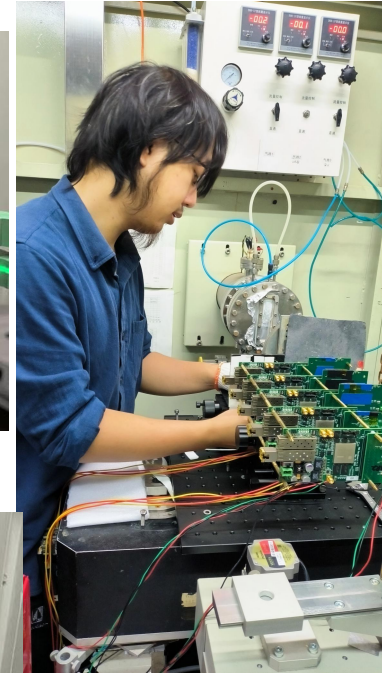
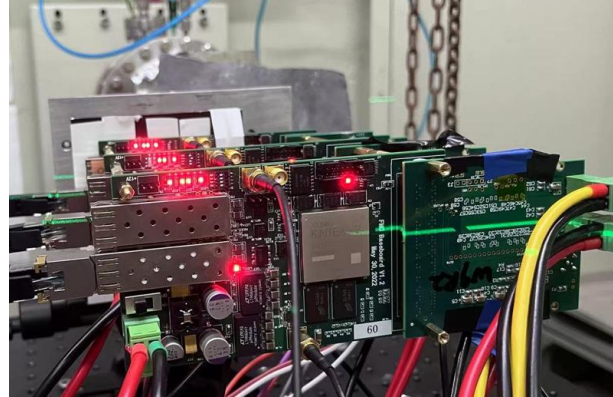
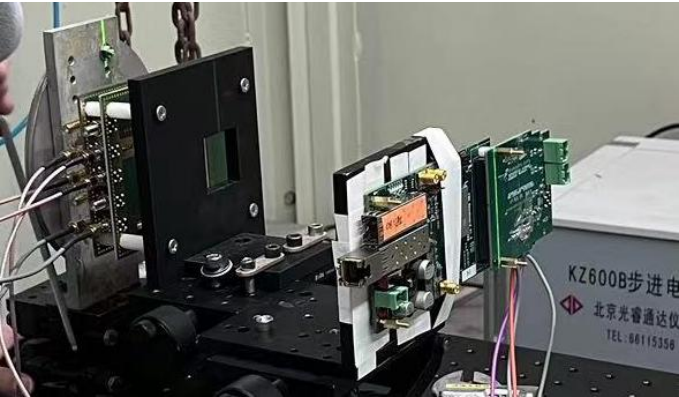


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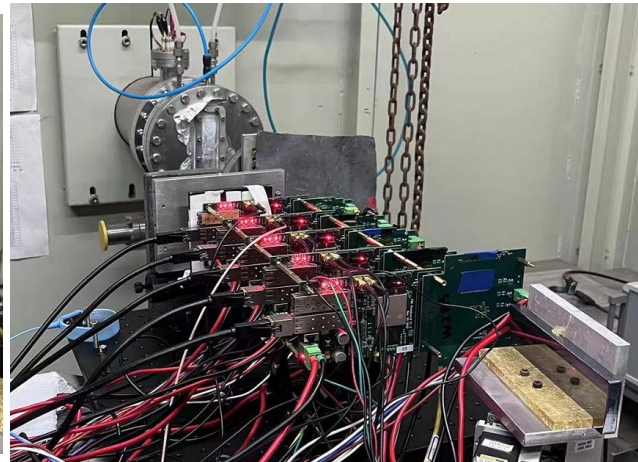
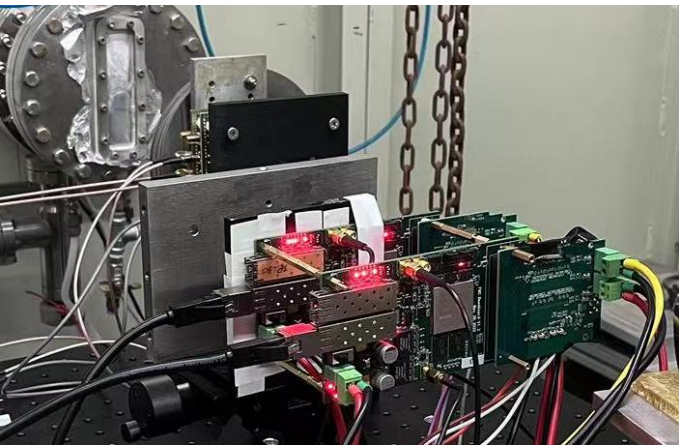




TaichuPix3 setup



- TaichuPix3 test board installation was step by step, from one to five.
- the threshold ITHR was set to 32, which corresponding to 300 e-

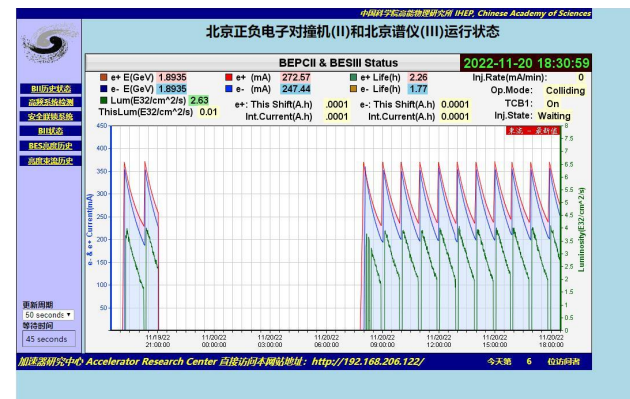
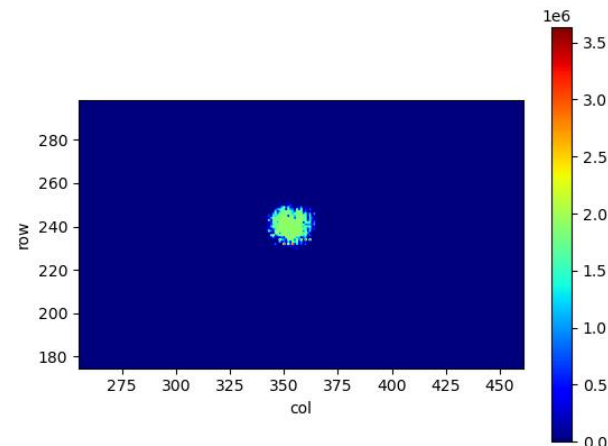


- Beam spot was set to 4mmx2mm
- 21-layer steel plate (1mm/layer) and 3 layers of lead (1mm/layer) was used to block X ray

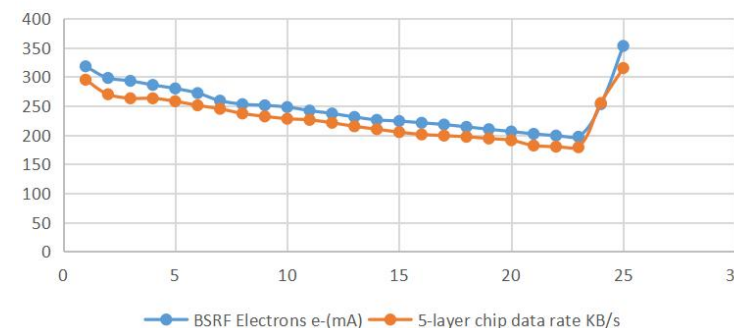


Data Acquisition

- A new DAQ software was used to acquire data. Laser test verified a capacity of 15MB/s for a chip (under 10KHz of infrared laser)
- The peak data rate was around 315 KB/s from 5 layers of TaichuPix3 board.
- The DAQ will be stopped automatically when there is no hit last for 5 seconds
- The data rate is consistent with the trend of electron energy changes



The data rate of 5-layer TaichuPix3 compared with BSRF electrons beam current





Timestamp calibration

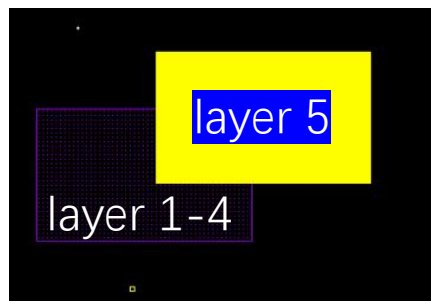
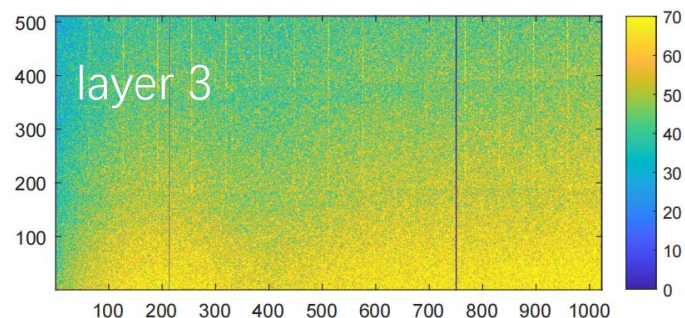
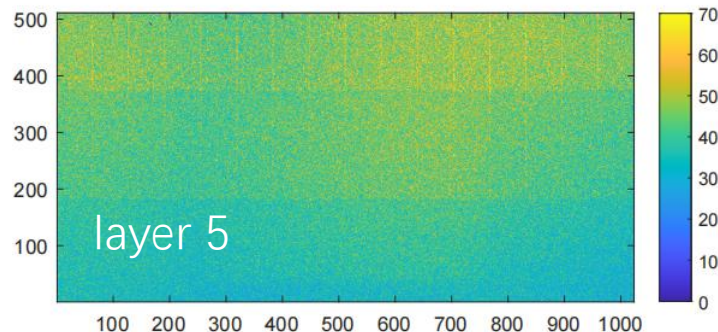
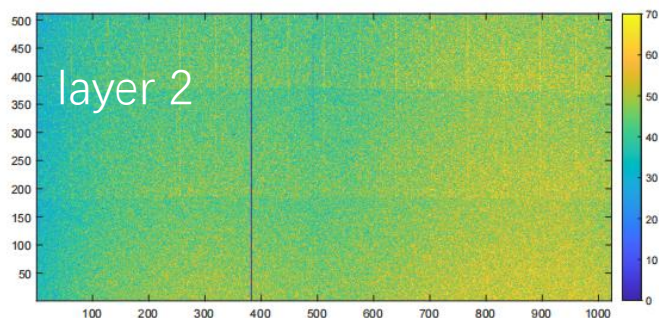
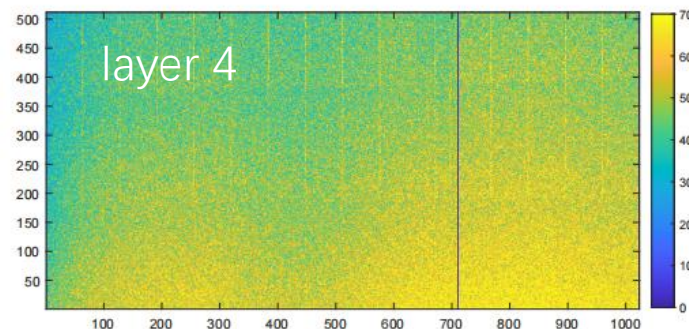
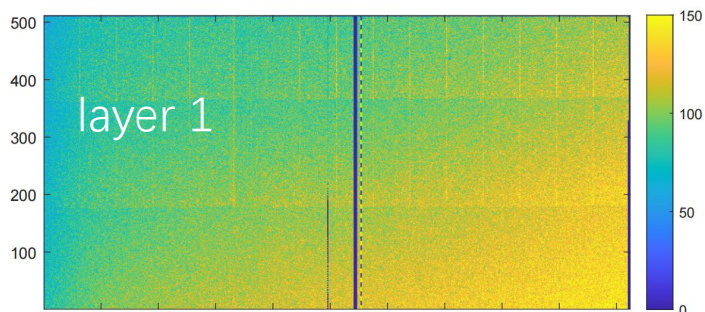
- For timestamp calibration, a chip self-test is necessary before the beam test. The chip level timestamp (time1) is normalized
- Clock of timestamp is running with 20MHz
- The coincidence data will be figured out by the same chip level timestamp, which recognized by a range of $3 \text{ time1}(\pm 1 \text{ time1})$

The screenshot shows five overlapping Notepad++ windows, each displaying a table of timestamp data. The windows are titled 'Run0651-Rundata-analyze-01.txt - 记事本' through 'Run0651-Rundata-analyze-05.txt - 记事本'. Each table has the following columns: row, col, time1, time2, chip_id, valid. Red boxes highlight the 'time1' column in each window.

row	col	time1	time2	chip_id	valid
520	310	29	236	13	1
520	307	29	236	13	1
520	308	29	236	13	1
520	301	29	236	13	1
520	302	29	236	13	1
520	303	29	236	13	1
520	300	29	236	13	1
520	305	29	236	13	1
520	306	29	236	13	1
519	307	29	236	13	1
520	304	29	236	13	1
519	301	30	236	13	1
519	302	30	236	13	1
519	303	30	236	13	1
519	300	30	236	13	1
520	309	30	236	13	1
519	310	30	236	13	1
518	307	30	236	13	1
519	308	30	236	13	1
518	301	30	236	13	1
518	302	30	236	13	1



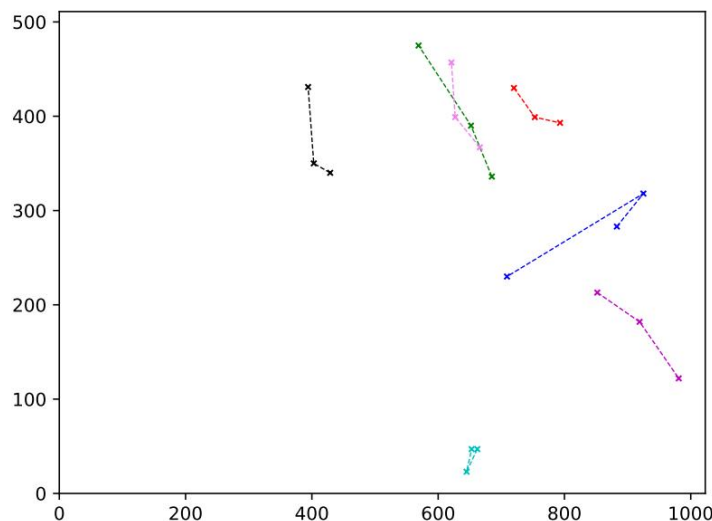
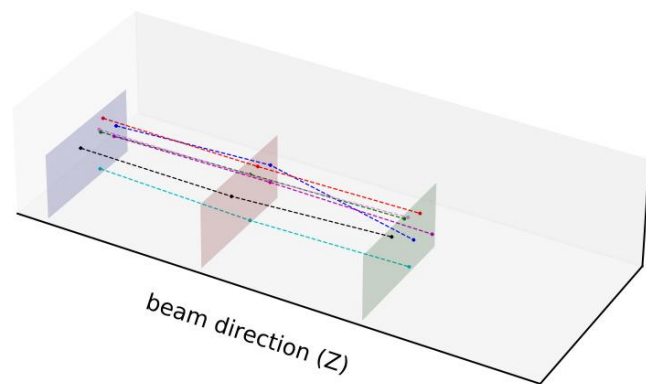
Hitmap of 5 layer TaichuPix3 chips



- layer1 and layer2 were the standard chip fabrication process, the threshold is around 300 e⁻
- layer3 and layer 4 was with modified process that has a lower threshold(165e⁻) at the same settings.
- layer5 has a different position and with 25% region overlap to first 4 layers
- The hitmap agrees with our expectation



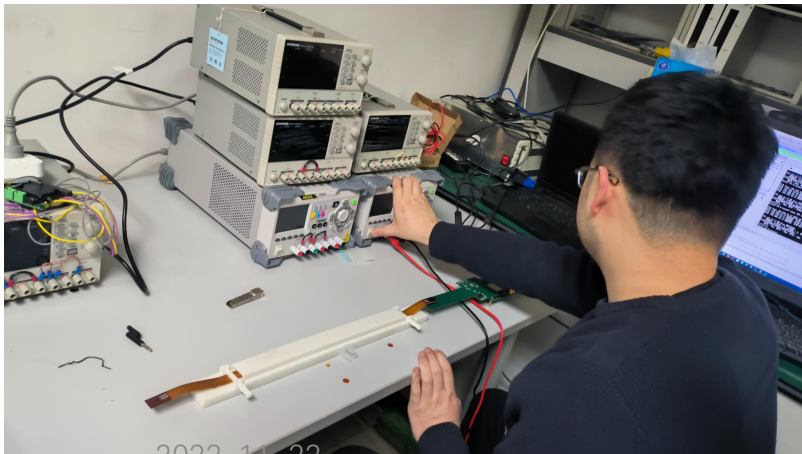
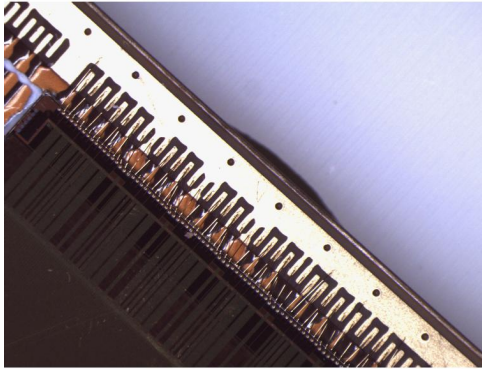
Preliminary Coincidence electrons analysis



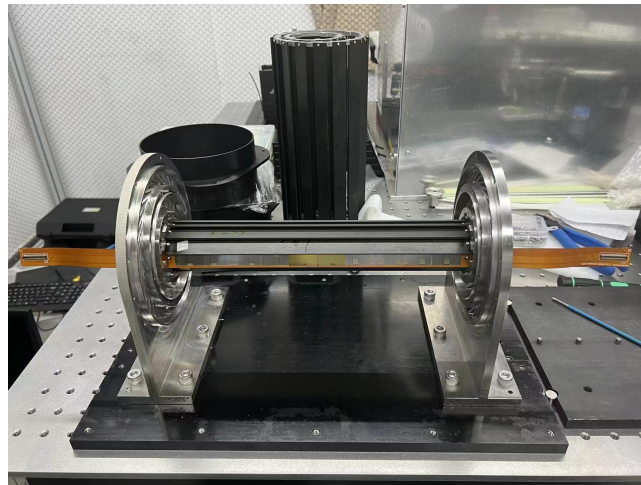
- For Taichupix3, a chip region of 2.56cm x 1.28cm, the coincident track electrons are around 10509 after 150mins data acquisition within first 4 layers.
- The average hit rate of electrons is about 70 coincident tracks per minutes within first 4 layers of chips.
- >300k coincidence events were recorded
- The 3D figure and projection shows the preliminary coincidence track without alignment, more results will be presented later.



Vertex detector module progress



2022-11-23

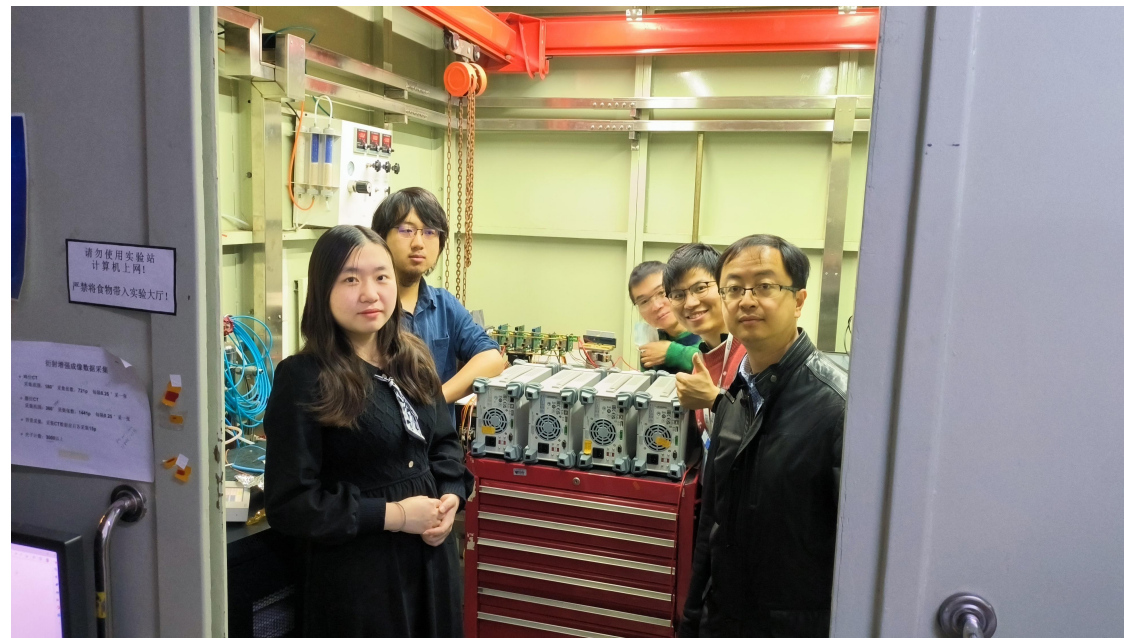
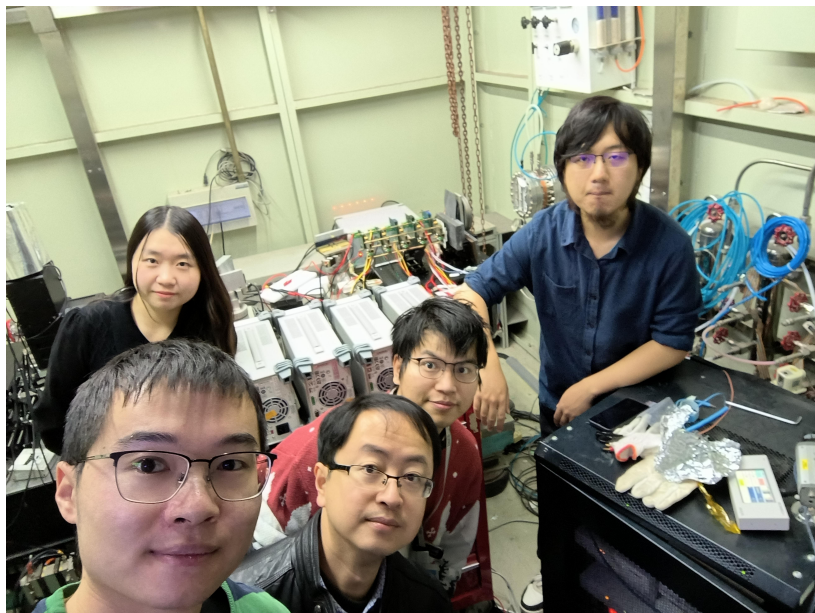


- ✓ The flex boards wirebonding were verified.
- ✓ The electronics test for flex board is on going.
- ✓ The ladder installation was proved.
- ✓ The fully founction of detector was tested in BSRF, including the TaichuPix3 chips, the firmware and DAQ. The algorithm of events analysis will be completed soon.
- ✓ To DESY, the PCB and ladder will be brought there together in case of the ladder risk.



Summary

- The fully function of detector based on PCB was proved in BSRF
- >300k tracks were recorded, and the analysis for these events will be presented later.
- We plan to go to DESY on 9 DEC 2022, the PCB and ladder will be brought there together.





- *More results are under processing.*

Thanks for your attention!